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Yasutomi
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HEADPHONE
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[73]
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Term: $\mathbf{1 4}$ Years
[21]
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[52]
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[58] Field of Search D14/206, 223, 224. 249; 181/129, 130,
$137 ; 379 / 430,431,444$

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## [57]

## CLAIM

The ornamental design for a headphone, as shown and described.

## DESCRIPTION

FIG. 1 is a perspective view of a first embodiment of a headphone showing my new design;
FIG. $\mathbf{2}$ is a top plan view thereof;
FIG. 3 is a left side elevational view thereof, a right side elevational view being a mirror image;

FIG. 4 is a front elevational view thereof;
FIG. 5 is a bottom plan view thereof;
FIG. 6 is a rear elevational view thereof;
FIG. 7 is a perspective view of a second embodiment of a headphone showing my new design;

FIG. $\mathbf{8}$ is a top plan view thereof;
FIG. 9 is a left side elevational view thereof, a right side elevational view thereof being a mirror image;

FIG. 10 is a front elevational view thereof;
FIG. 11 is a bottom plan view thereof; and,
FIG. $\mathbf{1 2}$ is a rear elevational view thereof.

1 Claim, 8 Drawing Sheets



FIG. 1


FIG. 2


FIG. 3


FIG. 4


FIG. 5


FIG. 6


FIG. 7


FIG. 8


FIG. 9


FIG. 10


FIG. 11


FIG. 12

